# **ITEQ** Corporation

**2022 Second Quarter Earnings Result** 

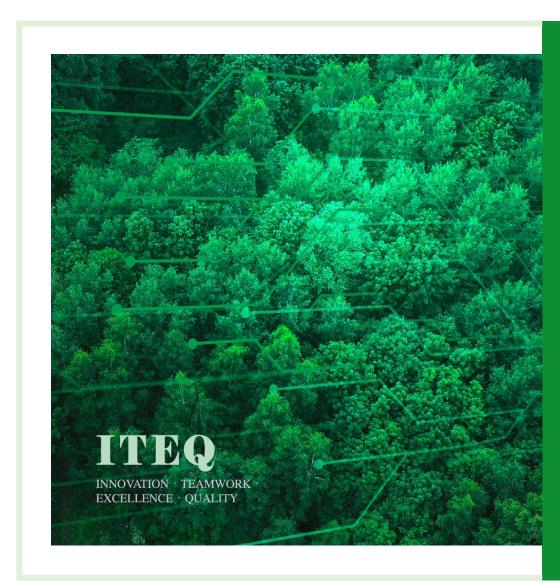


INNOVATION. TEAMWORK. EXCELLENCE. QUALITY

September 2022

### **Disclaimer Statement**

- This presentation and release contain "forward-looking statements" which may include projections of future results of operations, financial condition or business prospects based on our own information and other sources.
- Our actual results of operations, financial condition or business prospects may differ from those expressed or implied in these forward-looking statements for a variety of reasons, including but not limited to market demand, price fluctuations, competition, international economic conditions, supply chain issues, exchange rate fluctuations and other risks and factors beyond our control.
- The forward-looking statements in this release reflect the current belief of ITEQ as of the date of this release. ITEQ undertakes no obligation to update these forward-looking statements for events or circumstances that occur subsequent to such date.





## **Company Overview**

Establishment April 10<sup>th</sup>, 1997

**Headquarters** HsinChu, Taiwan

Capital NT\$3,830 million

Employees ~4,000



CEO Audrey Tsai

Main Products

Copper Clad Laminate (CCL) & Prepreg (PP) | Masslam service | Flexible CCL

#### **Revenue (NT\$ billion) Revenue by Application (FY21)** Automotive, 11% Consumer **Electronics**, 32.5 Smartphone, 27% 9% 25.4 23.8 19.1 19 2015 2017 2018 2019 2020 2021 2016 Networking,

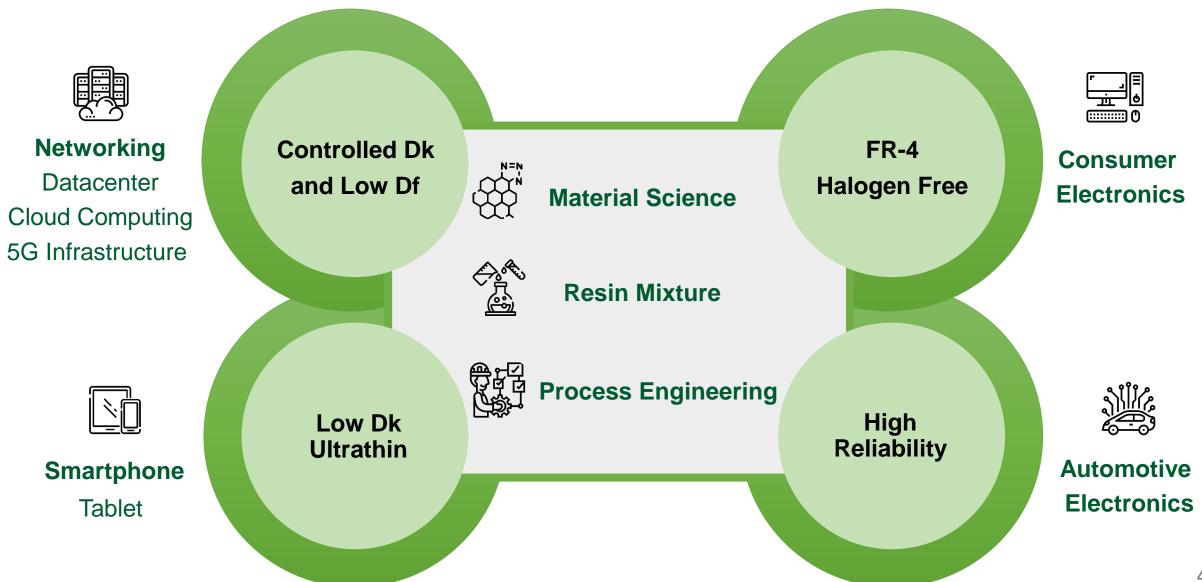
53%



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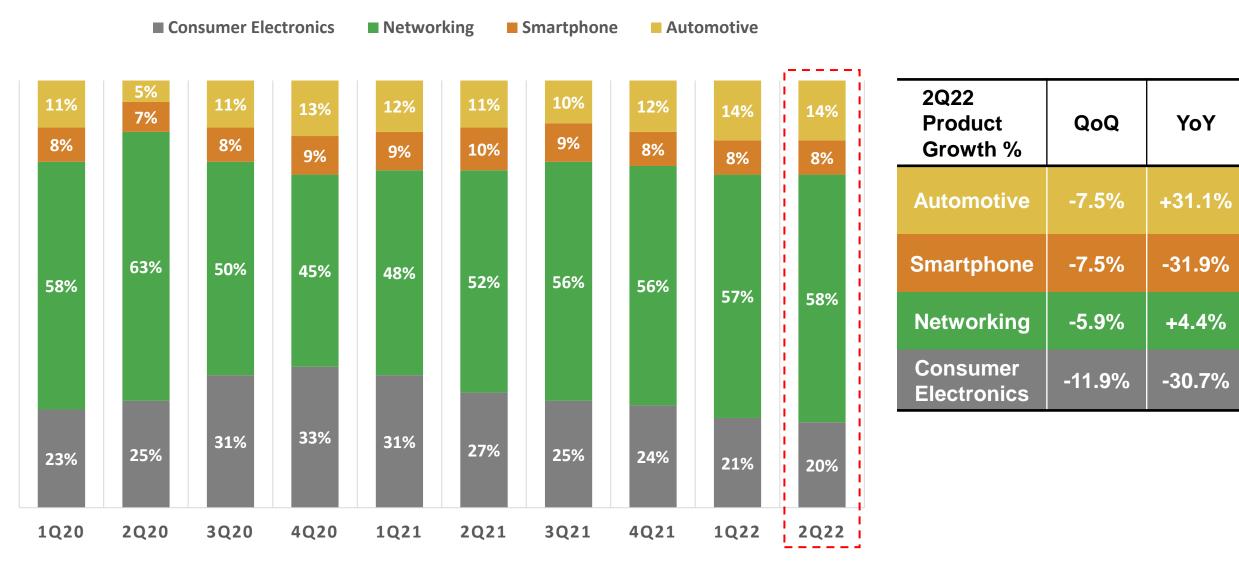
## **Key Technology Applications**





### 1Q20~2Q22 Product Mix

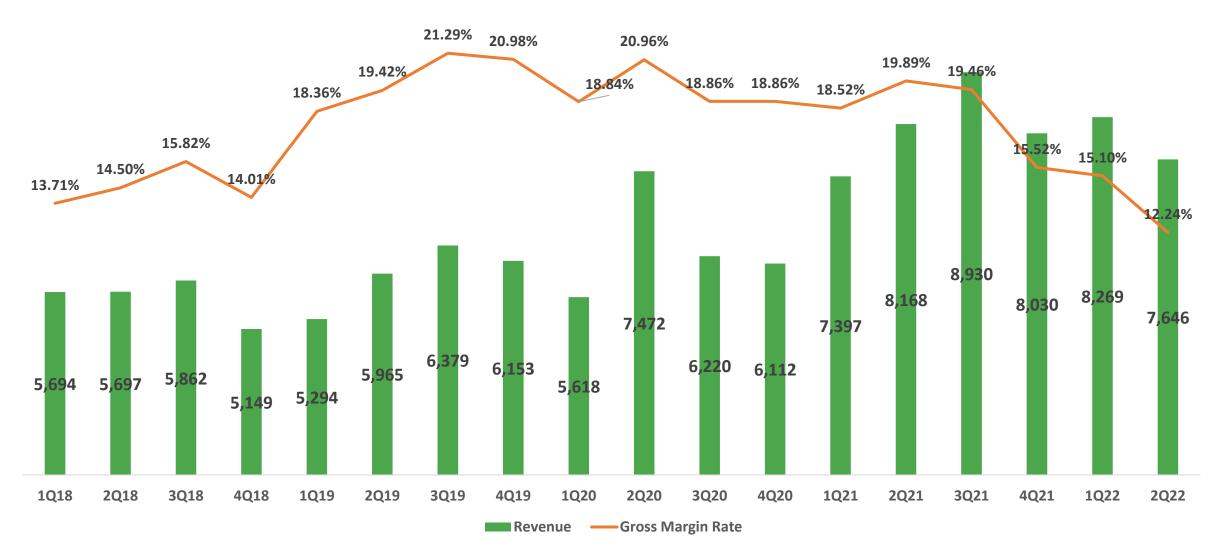


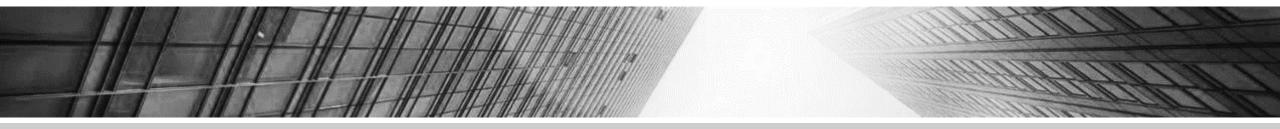


### **Revenue & Gross Margin Rate**



(Million \$NTD)





## **Growth Strategy Blueprint**



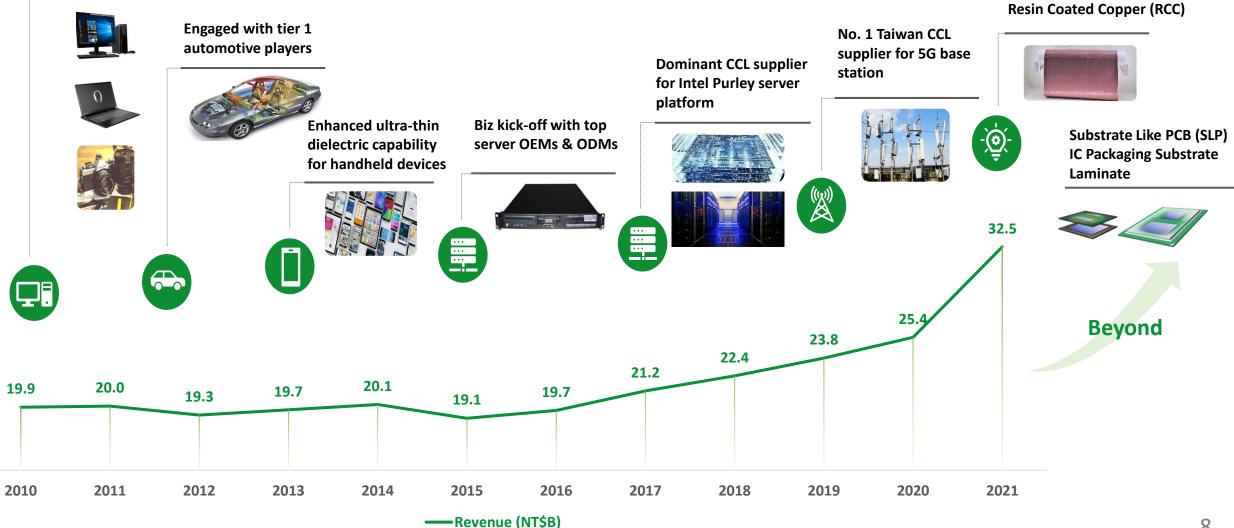


## Path of Innovation

ITEQ

New product for HDI PCB:

Widely adopted in consumer electronics



## Market Share Leader in Specialty Laminate



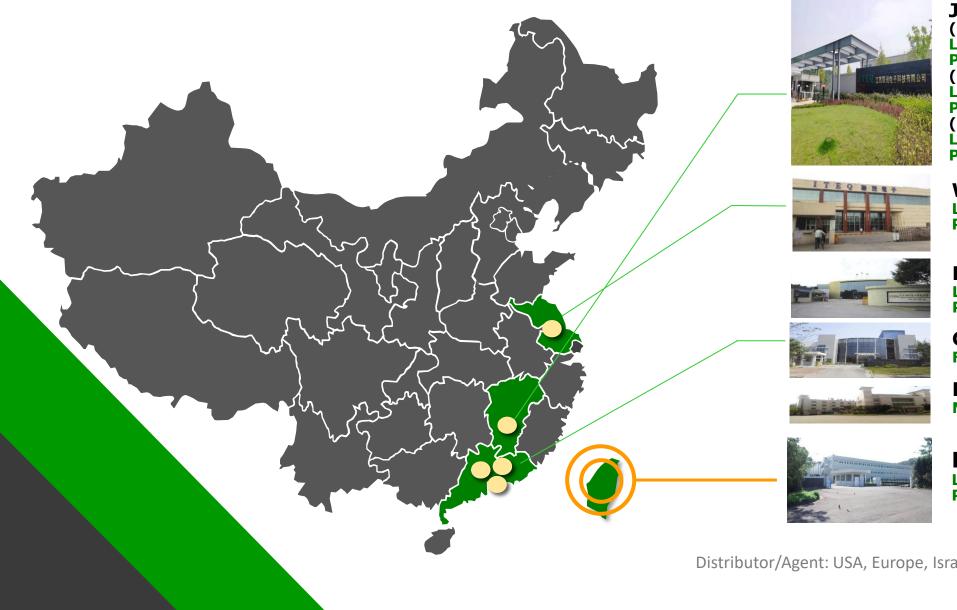
\*Specialty Laminate includes: High speed, package substrate, RF Source: Prismark Report, 2022/05

#### **ITEQ: Leading CCL supplier**

- Worldwide top supplier in high speed / frequency laminate
- Cutting-edge technology with MP track record
- Secular growth momentum in 5G network and data center opportunities
- Rising EV market to boost demand for high speed / frequency automotive CCL



## Manufacturing Site & Capacity – Expansion PlaniteQ



#### JiangXi Plant

(Phase I) - 2020 Laminate (600K SHT/Month) Prepreq (3,500K M/Month) (Phase II) - 2021 Laminate (600K SHT/Month) Prepreq (3,500K M/Month) (Phase III) - 2022 & 2023 Laminate (1,200K SHT/Month) Prepreg (5,000K M/Month)

WuXi Plant Laminate (1,650K SHT/Month) Prepreq (8,000K M/Month)

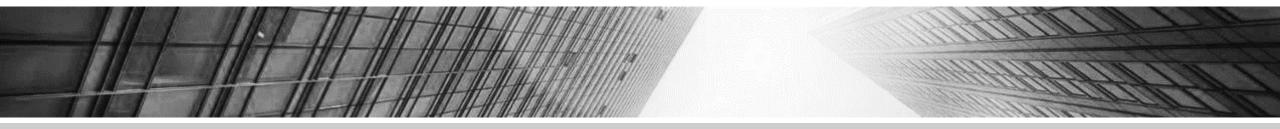
**DongGuan Plant** Laminate (1,000K SHT/Month) Prepreq (4,000K M/Month)

**GuangZhou Plant** FCCL(1,450 K M<sup>2</sup>/Month)

HuangJiang Plant Masslam Service(500K SQFT/Month)

HsinChu (Headquarters) Laminate(400K SHT/Month) Prepreg (2,400K M/Month)

Distributor/Agent: USA, Europe, Israel, Korea, Japan and Singapore



## Market Trend & Growth Drivers ITEQ



## **Datacenter Server Platform Upgrade**

	Platform	Purley		Whitley		Eagle Stream	
	CPU	Skylake	Cascade Lake	Copper Lake	Ice lake	Sapphire Rapids	Emerald Rapids
	Nano Process	14 nm	14 nm+	14 nm++	10 nm	Intel 7	Intel 7
Intel	PCIe Generation	PCIe 3.0	PCIe 3.0	PCIe 3.0	PCle 4.0	PCle 5.0	PCIe 5.0
	MP Time	2017 Q3	2019 Q3	Cancel	2021 Q1	2023 H1	2023
	CCL Material	Mid Loss	Mid Loss	Cancel	Low Loss	Very Low Loss	Very Low Loss
	Layer count	8 to 12	8 to 12	Cancel	12 to 16	16 to 20	16 to 20

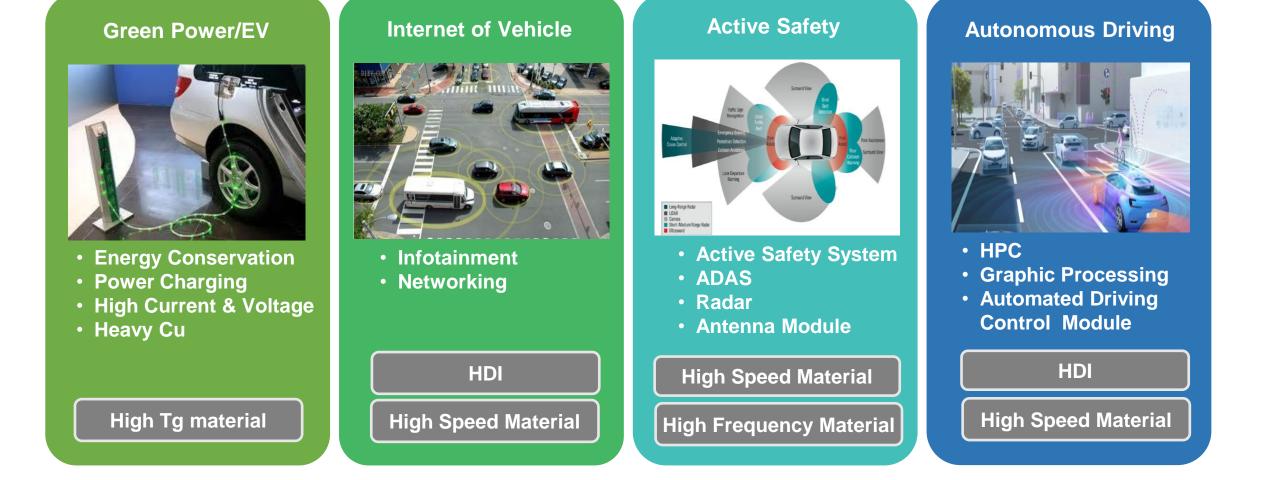
	Architecture	Zen	Zen2	Zen3	Zen4
	CPU	Naples	Rome	Milan	Genoa
	Nano Process	14 nm (Global Foundries)	7 nm (TSMC)	7 nm (TSMC)	5 nm (TSMC)
AMD	PCIe Generation	PCIe 3.0	PCIe 4.0	PCIe 4.0	PCIe 5.0
	MP Time	2017 Q3	2019 Q3	2020 Q4	2022 Q4
	CCL Material	Mid Loss	Low Loss	Low Loss	Very Low Loss
	Layer count	8 to 12	12 to 16	12 to 16	16 to 20



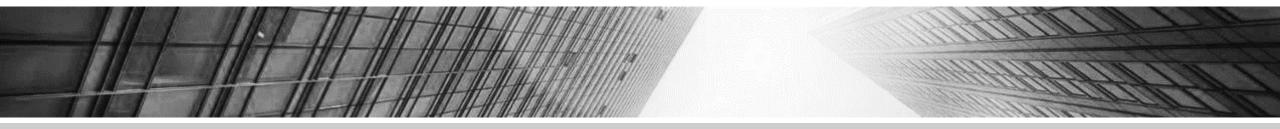
Datacenter Equipment Cyclical Upgrade to Drive the Following;

- Corresponding CCL material upgrade
- Increase consumption and layer counts for CCL

## **Advanced Auto Application Opportunities**



EV, IoV and Active Safety to boost demand for high performance automotive CCL



## **2Q22 Financial Results**





## 2Q22 Income Statement

NTD \$Million	2Q22	1Q22	2Q21	QoQ	YoY
Revenue	7,646	8,269	8,168	-7.5%	-6.4%
Gross Profit	936	1,249	1,625	-25.1%	-42.4%
Operating Expense	486	605	483	-19.7%	0.6%
Operating Profit	450	644	1,142	-30.1%	-60.6%
Non-Op Income / Loss	146	332	(19)		
Income before Tax	596	976	1,123	-38.9%	-46.9%
Tax Expense	161	167	263		
Net Income to Parent	435	809	860	-46.2%	-49.4%
EPS(NT\$)	1.14	2.11	2.58	-46.0%	-55.8%
Key Financial Ratio					
Gross Margin	12.24%	15.10%	19.90%		
Operating Expense Ratio	6.36%	7.32%	5.92%		
Operating Margin	5.89%	7.79%	13.98%		
Effective Tax Rate	27.01%	17.11%	23.42%		
Net Margin	5.69%	9.78%	10.53%		

### 2Q22 Balance Sheet

NTD \$Million	2Q22	1Q22	2Q21
Total Assets	34,043	35,614	32,698
Cash	3,873	3,711	2,749
Marketable Securities	4	5	5
NR / AR	13,799	14,377	13,403
Inventories	3,872	4,822	4,161
Fixed Assets	10,276	10,122	9,569
Total Liabilities	13,092	14,830	17,960
Short-term Debt	2,051	2,494	3,144
NP / AP	5,686	6,644	7,661
Long-term Debt		-	1,370
Total Equity	20,951	20,784	14,738
Key Financial Index			
Days Sales Outstanding	151	151	159
Days Sales of Inventory	64	69	64
Days Payable Outstanding	84	91	102
ROE (%)	13.60	15.73	20.80
ROA (%)	8.42	9.40	10.23
Debt ratio (%)	38.46	41.64	54.93
	La caracter de la composition		

## 2015 – 2021 Dividend Policy

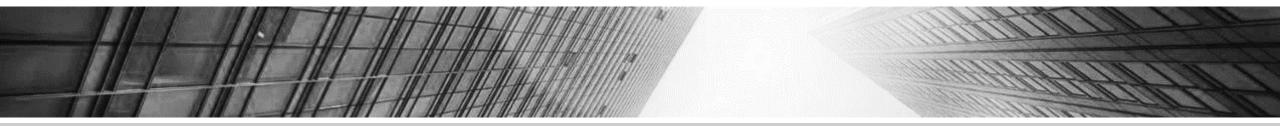
Year	EPS(NT\$)	Dividend(NT\$)	Cash Dividend(NT\$)	Pay-out Ratio(%)
2015	1.92	1.6	1.6	83%
2016	3.13	2.5	2.5	80%
2017	4.11	3.1	3.1	75%
2018	5.86	3.8	3.8	65%
2019	8.13	5.0	5.0	62%
2020	8.19	5.0	5.0	61%
2021	9.00	5.0	5.0	56%

\*New shares issuance of 30 million common shares concluded on March 31st 2020

\*\*New shares issuance of 50 million common shares concluded on September 2<sup>nd</sup> 2021; current total outstanding common share: 383 million

# Thank you

**Question and Comment** 



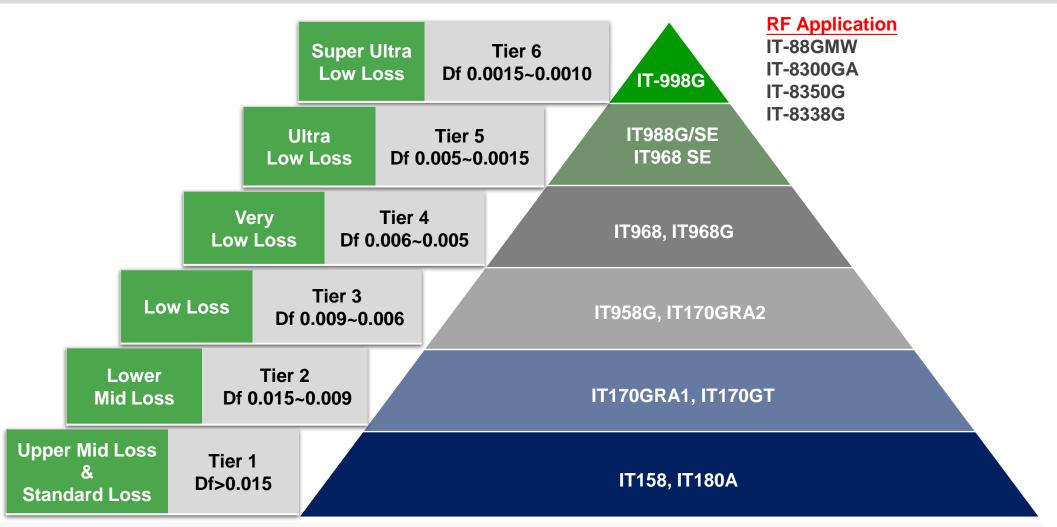
# Appendix





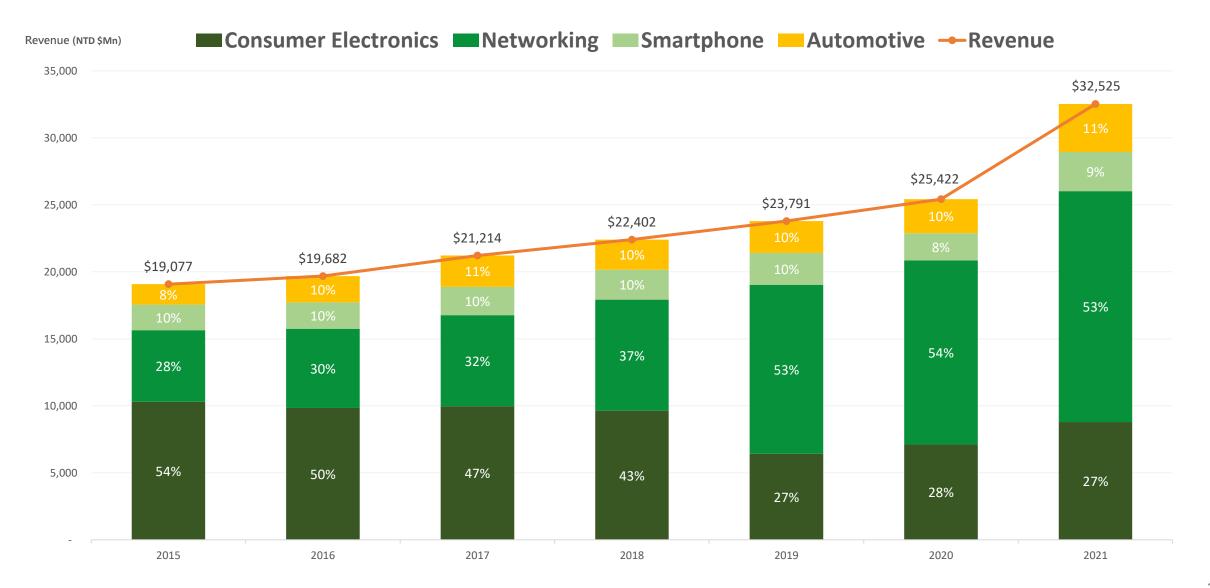
## Well-Expanded Product Line



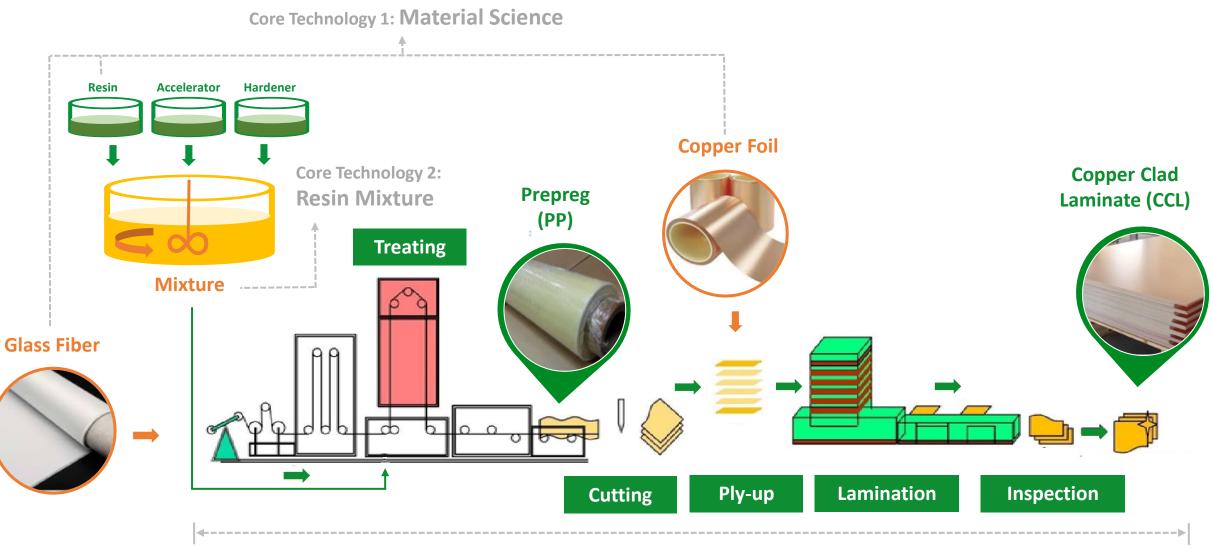


- The need for 5G commercialization and server upgrade to expedite the growth of high speed / frequency material demand
- ITEQ's market share in high speed / frequency material to uplift robustly

## 2015-2021 Mix Shifted Driven by Innovation ITEQ



## **CCL & PP Manufacturing Flow**



Core Technology 3: Process Engineering

## **CCL & PP Composite Structure**

